1. General description

Planar Maximum Efficiency General Application (MEGA) Schottky barrier rectifier with an integrated guard ring for stress protection, encapsulated in a SOD128 small and flat lead Surface-Mounted Device (SMD) plastic package.

2. Features and benefits

- Average forward current: I_{F(AV)} ≤ 4.5 A
- Reverse voltage: V_R ≤ 60 V
- Low forward voltage
- High power capability due to clip-bonding technology
- · Small and flat lead SMD plastic package
- AEC-Q101 qualified
- High temperature T_i ≤ 175 °C
- · Capable for reflow and wave soldering

3. Applications

- · Low voltage rectification
- High efficiency DC-to-DC conversion
- Switch mode power supply
- Reverse polarity protection
- · Low power consumption application

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _{F(AV)}	average forward current	δ = 0.5; f = 20 kHz; $T_{sp} \le$ 155 °C; square wave	-	-	4.5	А
V _R	reverse voltage	T _j = 25 °C	-	-	60	V
V _F	forward voltage	$I_F = 4.5 \text{ A}; t_p \le 300 \mu\text{s}; \delta \le 0.02;$ $T_j = 25 ^{\circ}\text{C}; \text{ pulsed}$	-	460	530	mV
I _R	reverse current	$V_R = 60 \text{ V}; T_j = 25 ^{\circ}\text{C}; \text{ pulsed}$	-	115	400	μΑ



5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode[1]		к . Д
2	A	anode	1 2	sym001
			CFP5 (SOD128)	

^[1] The marking bar indicates the cathode.

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PMEG6045ETP	CFP5	plastic, surface mounted package; 2 terminals; 4 mm pitch; 3.8 mm x 2.6 mm x 1 mm body	SOD128

7. Marking

Table 4. Marking codes

Type number	Marking code
PMEG6045ETP	DC

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V_R	reverse voltage	T _j = 25 °C		-	60	V
l _F	forward current	T _{sp} = 150 °C		-	6.3	Α
I _{F(AV)}	average forward current	δ = 0.5; f = 20 kHz; $T_{amb} \le 35$ °C; square wave	[1]	-	4.5	А
		δ = 0.5; f = 20 kHz; $T_{sp} \le 155$ °C; square wave		-	4.5	А
I _{FSM}	non-repetitive peak forward current	t_p = 8 ms; square wave; $T_{j(init)}$ = 25 °C		-	70	A
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[2]	-	750	mW
			[3]	-	1250	mW
			[1]	-	2500	mW
Tj	junction temperature			-	175	°C
T _{amb}	ambient temperature			-55	175	°C
T _{stg}	storage temperature			-65	175	°C

- [1] Device mounted on a ceramic Printed-Circuit Board (PCB), Al₂O₃, standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
from	thermal resistance from junction to ambient		[1] [2]	-	-	200	K/W
			[1] [3]	-	-	120	K/W
			[1] [4]	-	-	60	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point		<u>[5]</u>	-	-	12	K/W

- [1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P_R are a significant part of the total power losses.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².
- [4] Device mounted on a ceramic PCB, Al₂O₃, standard footprint.
- [5] Soldering point of cathode tab.

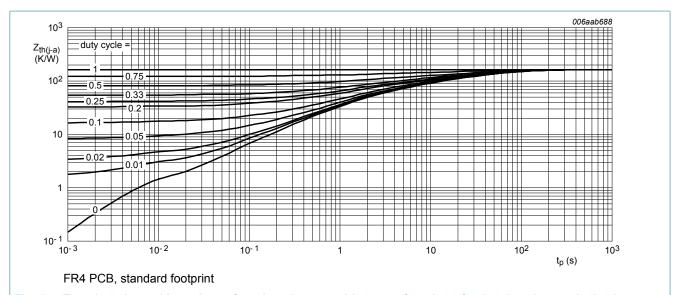


Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

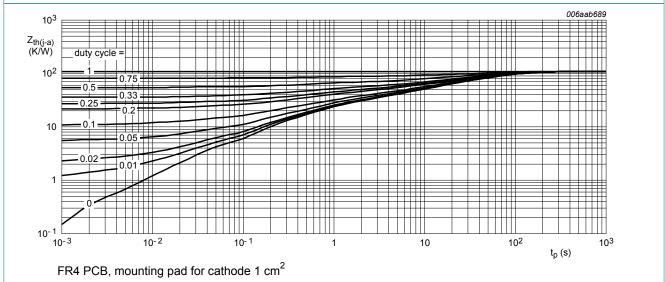
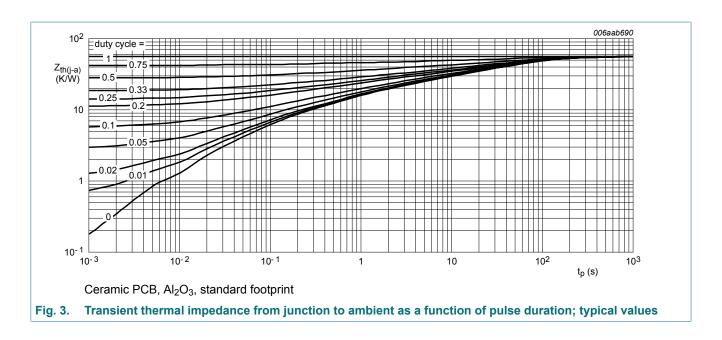


Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _F	forward voltage	I_F = 0.1 A; $t_p \le 300 \text{ μs}$; $\delta \le 0.02$; T_j = 25 °C; pulsed	-	275	310	mV
		$I_F = 0.5 \text{ A; } t_p \le 300 \text{ µs; } \overline{o} \le 0.02;$ $T_j = 25 \text{ °C; pulsed}$	-	325	-	mV
		I_F = 1 A; t_p ≤ 300 μs; δ ≤ 0.02; T_j = 25 °C; pulsed	-	355	400	mV
		$I_F = 1.5 \text{ A}; t_p \le 300 \text{ µs}; \delta \le 0.02;$ $T_j = 25 \text{ °C}; \text{ pulsed}$	-	375	-	mV
		$I_F = 2 \text{ A}; t_p \le 300 \text{ µs}; \delta \le 0.02;$ $T_j = 25 \text{ °C}; \text{ pulsed}$	-	390	440	mV
		$I_F = 3 \text{ A}; t_p \le 300 \text{ µs}; \delta \le 0.02;$ $T_j = 25 \text{ °C}; \text{ pulsed}$	-	420	475	mV
		$I_F = 4 \text{ A}; t_p \le 300 \text{ µs}; \delta \le 0.02;$ $T_j = 25 \text{ °C}; \text{ pulsed}$	-	450	510	mV
		I_F = 4.5 A; $t_p \le 300 \text{ μs}$; $\delta \le 0.02$; T_j = 25 °C; pulsed	-	460	530	mV
R	reverse current	$V_R = 5 \text{ V}; T_j = 25 ^{\circ}\text{C}; \text{ pulsed}$	-	7	20	μΑ
		V _R = 10 V; T _j = 25 °C; pulsed	-	9	40	μA
		V _R = 30 V; T _j = 25 °C; pulsed	-	20	80	μA
		V _R = 60 V; T _j = 25 °C; pulsed	-	115	400	μA
		V _R = 10 V; T _j = 125 °C; pulsed	-	9	-	mA
		V _R = 60 V; T _j = 125 °C; pulsed	-	70	300	mA
C _d	diode capacitance	V _R = 1 V; f = 1 MHz; T _j = 25 °C	-	575	-	pF
		V _R = 10 V; f = 1 MHz; T _j = 25 °C	-	200	-	pF
rr	reverse recovery time	$I_F = 0.5 \text{ A}$; $I_R = 0.5 \text{ A}$; $I_{R(meas)} = 0.1 \text{ A}$; $I_{j} = 25 \text{ °C}$	-	20	-	ns
V_{FRM}	peak forward recovery voltage	I _F = 1 A; dI _F /dt = 40 A/μs; T _j = 25 °C	-	385	-	mV

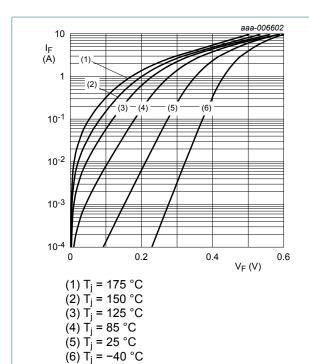


Fig. 4. Forward current as a function of forward voltage; typical values

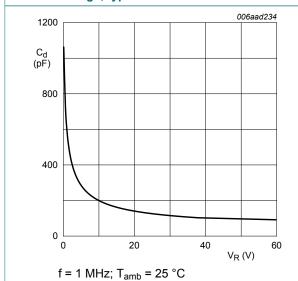


Fig. 6. Diode capacitance as a function of reverse voltage; typical values

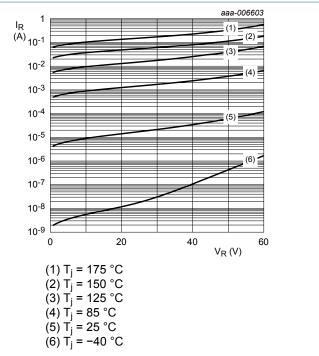
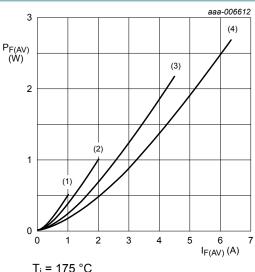


Fig. 5. Reverse current as a function of reverse voltage; typical values



 $T_j = 175 \,^{\circ}\text{C}$ (1) $\delta = 0.1$ (2) $\delta = 0.2$ (3) $\delta = 0.5$

 $(4) \delta = 1$

Fig. 7. Average forward power dissipation as a function of average forward current; typical values

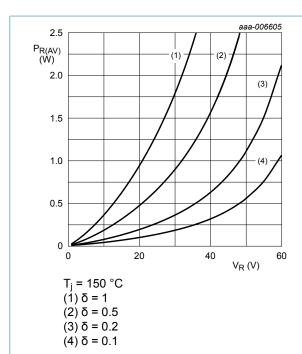


Fig. 8. Average reverse power dissipation as a function of reverse voltage; typical values

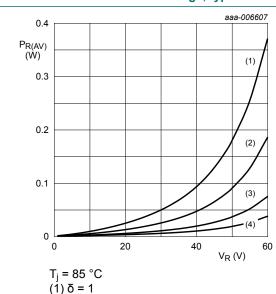


Fig. 10. Average reverse power dissipation as a function of reverse voltage; typical values

 $(2) \delta = 0.5$

 $(3) \delta = 0.2$

 $(4) \delta = 0.1$

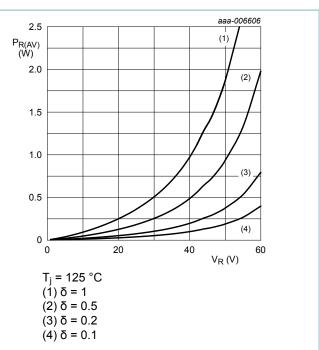


Fig. 9. Average reverse power dissipation as a function of reverse voltage; typical values

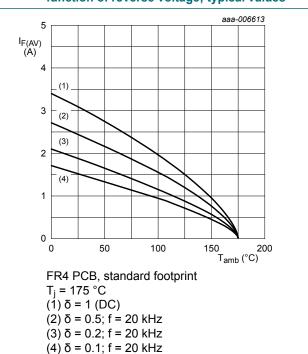
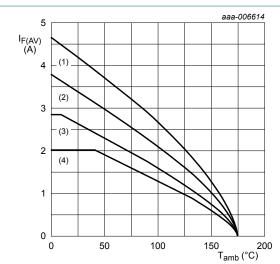


Fig. 11. Average forward current as a function of ambient temperature; typical values

Nexperia PMEG6045ETP

High-temperature 60 V, 4.5 A Schottky barrier rectifier



FR4 PCB, mounting pad for cathode 1 cm²

T_i = 175 °C

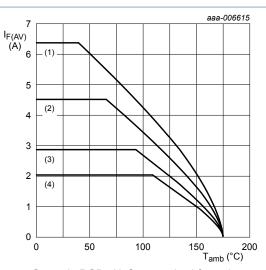
 $(1) \delta = 1 (DC)$

(2) $\delta = 0.5$; f = 20 kHz

(3) δ = 0.2; f = 20 kHz

(4) δ = 0.1; f = 20 kHz

Fig. 12. Average forward current as a function of ambient temperature; typical values



Ceramic PCB, Al₂O₃, standard footprint

 $T_i = 175$ °C

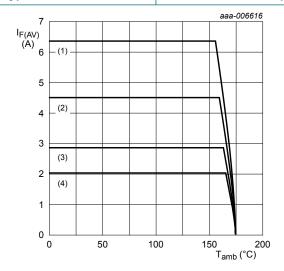
 $(1) \delta = 1 (DC)$

(2) δ = 0.5; f = 20 kHz

(3) δ = 0.2; f = 20 kHz

(4) $\delta = 0.1$; f = 20 kHz

Fig. 13. Average forward current as a function of ambient temperature; typical values



 $T_i = 175 \,{}^{\circ}\text{C}$

 $(1) \delta = 1 (DC)$

(2) $\delta = 0.5$; f = 20 kHz

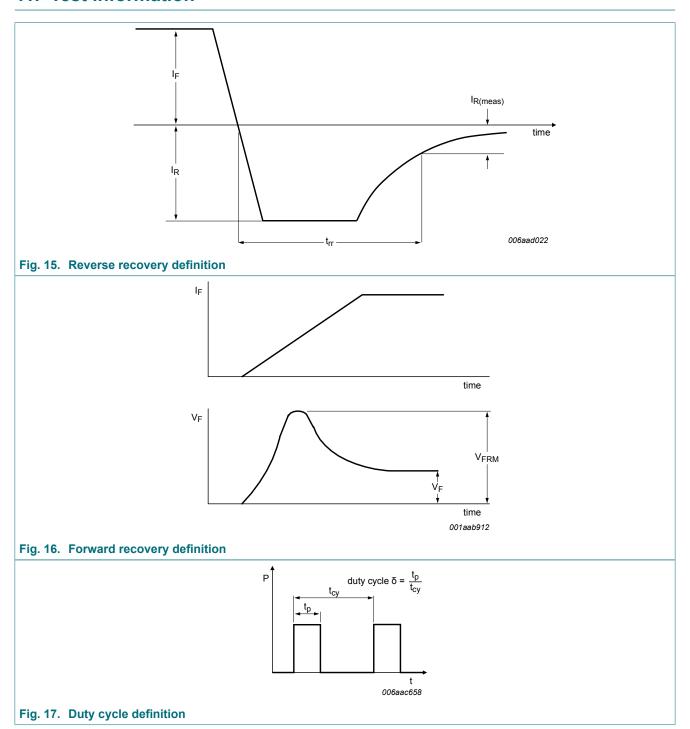
(3) δ = 0.2; f = 20 kHz

(4) δ = 0.1; f = 20 kHz

Fig. 14. Average forward current as a function of solder point temperature; typical values

9 / 15

11. Test information



The current ratings for the typical waveforms are calculated according to the equations: $I_{F(AV)} = I_M \times \delta$ with I_M defined as peak current, $I_{RMS} = I_{F(AV)}$ at DC, and $I_{RMS} = I_M \times \sqrt{\delta}$ with I_{RMS} defined as RMS current.

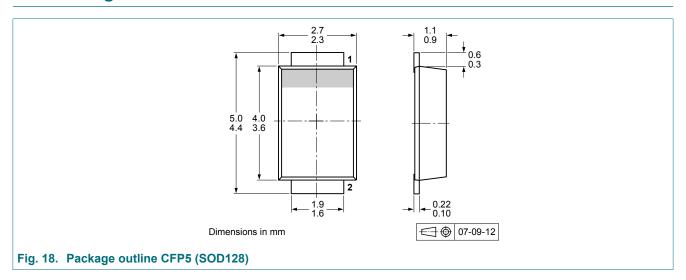
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High-temperature 60 V, 4.5 A Schottky barrier rectifier

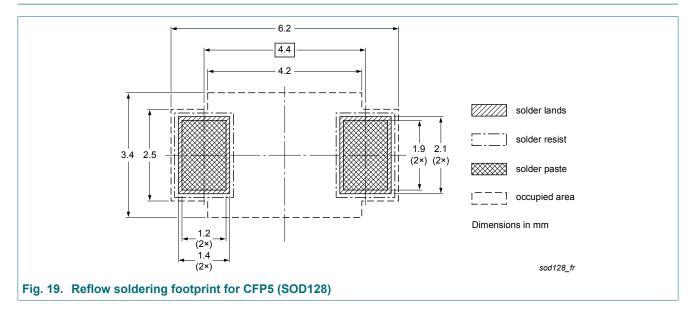
Quality information

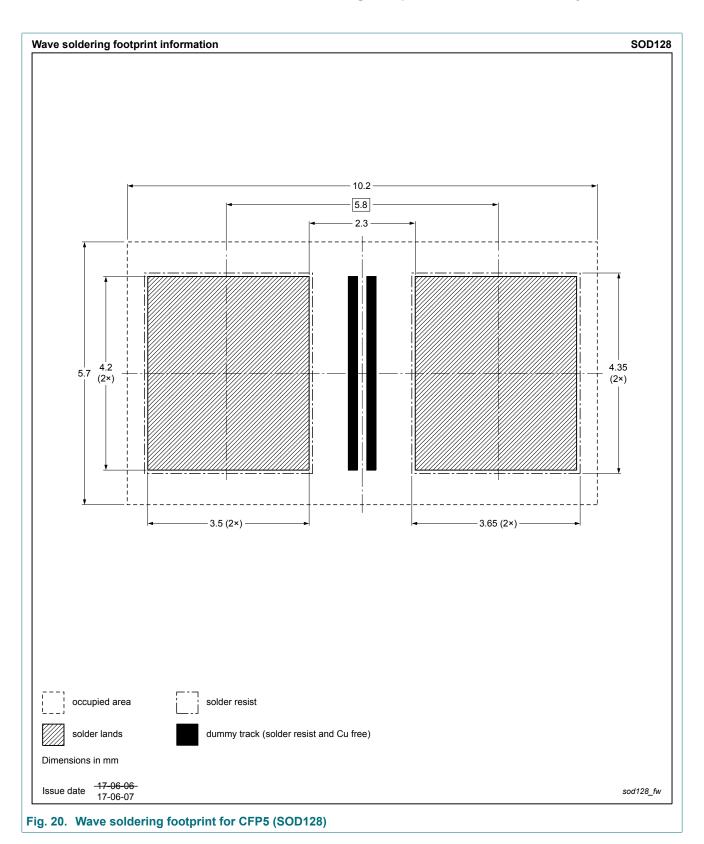
This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

12. Package outline



13. Soldering





14. Revision history

Table 8. Revision history

- the control of the								
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes				
PMEG6045ETP v.2	20180528	Product data sheet	-	PMEG6045ETP v.1				
Modifications:	 Features and benefits: Capable for reflow and wave soldering added Soldering: Wave soldering footprint added 							
PMEG6045ETP v.1	20130304	Product data sheet	-	-				

13 / 15

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
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PMEG6045ETP

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Contents

1.	General description	1
2.	Features and benefits	1
3.	Applications	1
4.	Quick reference data	1
5.	Pinning information	2
6.	Ordering information	2
7.	Marking	2
8.	Limiting values	3
9.	Thermal characteristics	3
10	. Characteristics	6
11.	. Test information	10
12.	. Package outline	11
13.	. Soldering	11
	. Revision history	
	Legal information	

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